



TGVC Series Vapour Chamber Vapour Chamber

Features

- Excellent XY conduction (heat spreading)
- Passive component with high stability (reliable)
- · Very lot thermal resistance
- 10 times more efficient than heat pipes

Applications

Best for high power applications

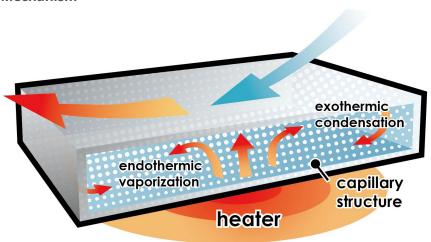
Consumer Electronics - Electric Vehicles, 5G, Autopilot System, Mobile Phone, AIOT, HPC (High Performance Computing), Server, IC, CPU, MOS, LED, Mother Board, Power Supply, Heat Sink, LCD-TV, Notebook, PC, Telecom Device, Wireless Hub, DDR II Module, etc.

Properties

Properties	TGVC-56-56-3.0-01	TGVC-106-70-3.0-01	Unit
Size	56x56	106x70	mm
Thickness	3.0	3.0	mm
Surface finishing	anti-oxidation		-

Different industries will require different specifications, please contact us directly for the most suitable specifications.

Mechanism



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TGVC-56-56-3.0-01 Vapour Chamber

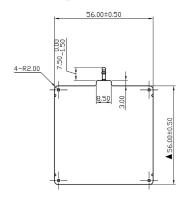
Product Description

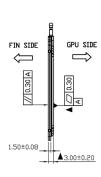
Dimension (mm): L:56mm / W: 56mm / T: 3.0mm

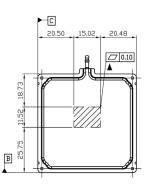
Operation Power: ≥110W

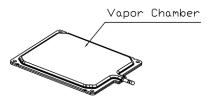


Thermal Resistance: ≤ 0.210°C/W









TGVC-106-70-3.0-01 Vapour Chamber

Product Description

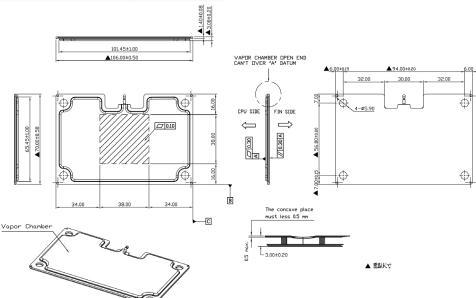
Dimension (mm): L:106mm / W: 70mm / T: 3.0mm

Operation Power: ≥150W



Product Details

Thermal Resistance: ≤ 0.160°C/W



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